

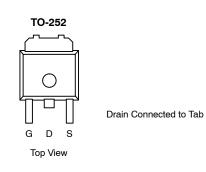
### APM2518NU-VB Datasheet

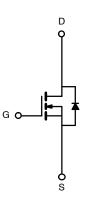
## N-Channel 20-V (D-S)175 °C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>			
20	0.0045 @ V <sub>GS</sub> = 4.5 V	100			
	0.006 @ V <sub>GS</sub> = 2.5 V	90			

#### FEATURES

- TrenchFET® Power MOSFET
- 175°C Maximum Junction Temperature
- 100% R<sub>g</sub> Tested





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)							
Parameter		Symbol	Limit	Unit			
Drain-Source Voltage	V <sub>DS</sub>	20	v				
Gate-Source Voltage		V <sub>GS</sub>	±15				
	$T_{C} = 25^{\circ}C$		100				
Continuous Drain Current <sup>a</sup>	$T_{C} = 100^{\circ}C$		80				
Pulsed Drain Current		I <sub>DM</sub>	200	A			
Continuous Source Current (Diode Conduction) <sup>a</sup>		IS	65				
	$T_{C} = 25^{\circ}C$		71				
Maximum Power Dissipation	$T_A = 25^{\circ}C$	P <sub>D</sub> —	8.3 <sup>b, c</sup>	W			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
	$t \leq 10$ sec.		15	18			
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	40	50	°C/W		
Maximum Junction-to-Case		R <sub>thJC</sub>	1.75	2.1			

Notes

a. Package Limited

b. Surface Mounted on 1" x 1" FR4 Board

 $\text{c.} \quad t \, \leq \, 10 \, \, \text{sec}$ 

Parameter	Symbol	Test Condition	Min	Typ <sup>a</sup>	Max	Unit		
Static								
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_{D}$ = 250 $\mu A$	20					
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\;\mu A$	0.5		1.5	V		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			±100	nA		
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1			
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 $^{\circ}\text{C}$			50	- μΑ		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	100			Α		
		$V_{GS}$ = 4.5 V, $I_D$ = 20 A		0.0045		Ω		
Drain-Source On-State Resistance <sup>b</sup>	r <sub>DS(on)</sub>	$V_{GS}$ = 4.5 V, $I_{D}$ = 20 A, $T_{J}$ = 125 $^{\circ}C$		0.0055				
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.006				
Forward Transconductanceb	9fs	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 40 \text{ A}$	20			S		
Dynamic <sup>a</sup>			•			•		
Input Capacitance	C <sub>iss</sub>			3660		pF		
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 20 V, f = 1 MHz		730				
Reverse Transfer Capacitance	C <sub>rss</sub>			375				
Total Gate Charge <sup>c</sup>	Qg			26	35			
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = 10 V, $~V_{GS}$ = 4.5 V, $I_{D}$ = 40 A		5		nC		
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			7		7		
Gate Resistance	Rg		1		3.7	Ω		
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			20	35			
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, \text{ R}_{I} = 0.25 \Omega$		120	190	ns		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$\begin{array}{l} V_{DD} = 10 \; V, \; R_L = 0.25 \; \Omega \\ I_D  \cong  40 \; A, \; V_{GEN} = 4.5 \; V, \; R_G = 2.5 \; \Omega \end{array}$		45	70			
Fall Time <sup>c</sup>	t <sub>f</sub>			20	35			
Source-Drain Diode Ratings ar	d Characteristi	c (T <sub>C</sub> = 25°C)						
Pulsed Current	I <sub>SM</sub>				100	A		
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	$I_{F}$ = 100 A, $V_{GS}$ = 0 V		1.2	1.5	V		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 40 A, di/dt = 100 A/µs		35	70	ns		

 Notes

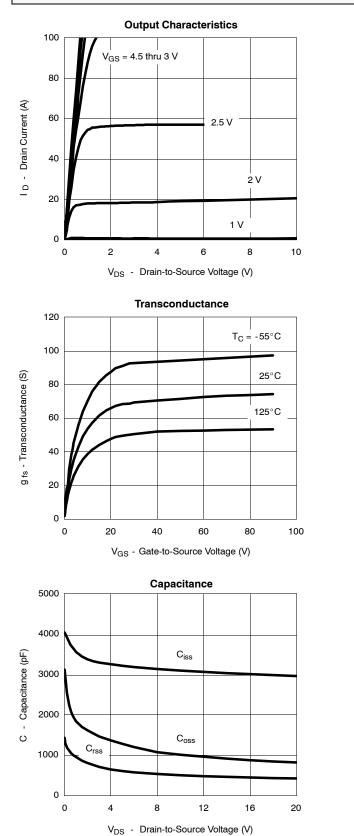
 a.
 Guaranteed by design, not subject to production testing.

 b.
 Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.

 c.
 Independent of operating temperature.

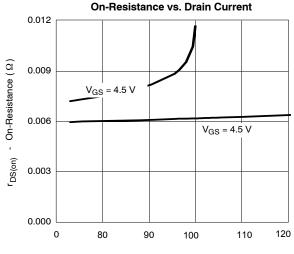


#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

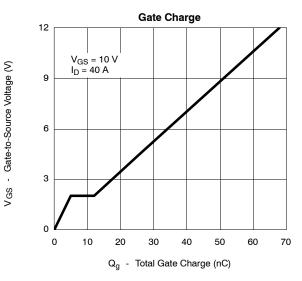


100 80 I D - Drain Current (A) 60 40  $T_C = 125^{\circ}C$ 20 25°C -55°C 0 0.0 0.5 1.0 1.5 2.0 2.5 3.0 3.5 V<sub>GS</sub> - Gate-to-Source Voltage (V)

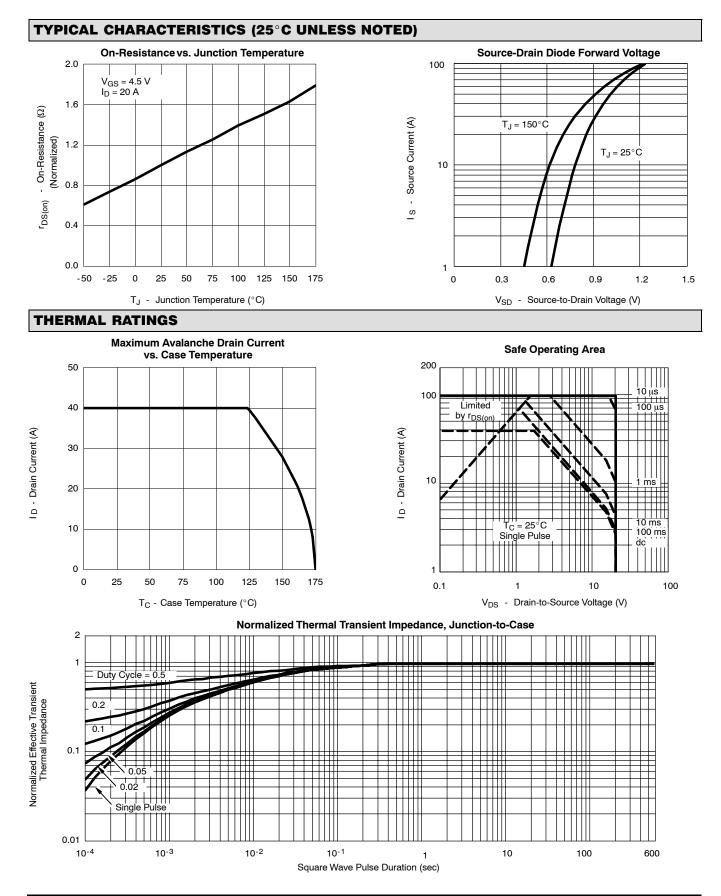
**Transfer Characteristics** 





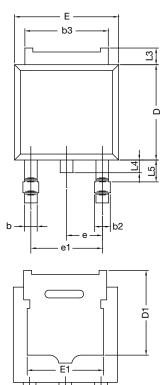


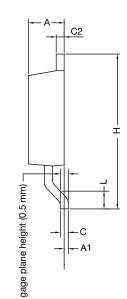






## **TO-252AA CASE OUTLINE**





	MILLIMETERS		INC	CHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56	BSC	0.180	BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347					

Note

• Dimension L3 is for reference only.



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